

Printed-circuit board connector - MCD 1,5/14-G1F-3,81 BK - 1732658

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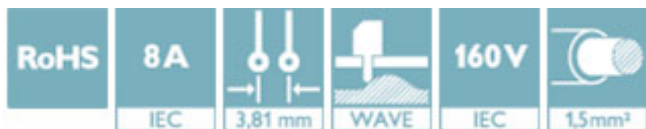


PCB headers, nominal current: 8 A, rated voltage (III/2): 160 V, nominal cross section: 1.5 mm², number of positions: 14, pitch: 3.81 mm, color: black, contact surface: Tin, mounting: Wave soldering, pin layout: Linear pinning, solder pin [P]: 3.5 mm

The figure shows a 10-pos. version with 20 contacts

Your advantages

- ✓ Well-known mounting principle allows worldwide use
- ✓ Screwable flange for superior mechanical stability
- ✓ Maximum flexibility when it comes to device design – one header for connectors with different connection technologies
- ✓ Conductor connection on several levels enables higher contact density



Key Commercial Data

Packing unit	50 pc
Minimum order quantity	50 pc
GTIN	
GTIN	4046356159746
Weight per Piece (excluding packing)	18.000 g
Custom tariff number	85366930
Country of origin	Germany
Note	Made to Order (non-returnable)

Technical data

Item properties

Brief article description	Feed-through header
Plug-in system	MINI COMBICON
Type of contact	Male connector
Range of articles	MCD 1,5/...-G1F
Pitch	3.81 mm
Number of positions	14

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Technical data

Item properties

Mounting type	Wave soldering
Pin layout	Linear pinning
Locking	Threaded flange
Number of levels	2
Number of connections	28
Number of potentials	28

Electrical parameters

Nominal current	8 A
Nom. voltage	160 V
Rated voltage	160 V
Rated voltage (III/2)	160 V
Rated voltage (II/2)	320 V
Rated surge voltage (III/3)	2.5 kV
Rated surge voltage (III/2)	2.5 kV
Rated surge voltage (II/2)	2.5 kV

Material data - contact

Note	WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/ JEDEC JESD 201
Contact material	Cu alloy
Surface characteristics	Tin-plated
Metal surface contact area (top layer)	Tin (3 - 5 µm Sn)
Metal surface contact area (middle layer)	Nickel (1 - 3 µm Ni),
Metal surface soldering area (top layer)	Tin (3 - 5 µm Sn)
Metal surface soldering area (middle layer)	Nickel (1 - 3 µm Ni)

Material data - housing

Housing color	black (9005)
Insulating material	PA
Insulating material group	I
CTI according to IEC 60112	600
Flammability rating according to UL 94	V0
Glow wire flammability index GWFI according to EN 60695-2-12	850
Glow wire ignition temperature GWIT according to EN 60695-2-13	775
Temperature for the ball pressure test according to EN 60695-10-2	125 °C

Dimensions for the product

Length [l]	21.9 mm
Width [w]	63.73 mm
Height [h]	26.5 mm
Pitch	3.81 mm
Height (without solder pin)	23 mm

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Dimensions for the product

Solder pin [P]	3.5 mm
Pin dimensions	0.8 x 0.8 mm

Dimensions for PCB design

Hole diameter	1.2 mm
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Packaging information

Type of packaging	packed in cardboard
Pieces per package	50
Denomination packing units	Pcs.

Ambient conditions

Ambient temperature (storage/transport)	-40 °C ... 70 °C
Ambient temperature (assembly)	-5 °C ... 100 °C
Ambient temperature (operation)	-40 °C ... 100 °C (dependent on the derating curve)

Air clearances and creepage distances

Clearances and creepage distances	IEC 60664-1:2007-04
Specification	IEC 60664-1:2007-04
Minimum clearance - inhomogeneous field (III/3)	1.5 mm
Minimum clearance - inhomogeneous field (III/2)	1.5 mm
Minimum clearance - inhomogeneous field (II/2)	1.5 mm
Minimum creepage distance value (III/3)	2 mm
Minimum creepage distance value (III/2)	1.5 mm
Minimum creepage distance value (II/2)	1.6 mm

Mechanical tests (A)

Test specification	IEC 61984
Insertion strength per pos. approx.	8 N
Withdraw strength per pos. approx.	5 N
Polarization when inserted requirement >20 N	Test passed
Contact holder in insert requirements >20 N	Test passed

Durability tests (B)

Specification	IEC 60512-9-1:2010-03
Insertion/withdrawal cycles	25
Contact resistance R ₂ 1st level	1.3 mΩ
Contact resistance R ₂ 2nd level	2.2 mΩ
Impulse withstand voltage at sea level	2.95 kV
Power-frequency withstand voltage	1.39 kV
Insulation resistance, neighboring positions	> 2 TΩ

Climatic tests (D)

Specification	ISO 6988:1985-02
Cold stress	-40 °C/2 h

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Climatic tests (D)

Thermal stress	100 °C/168 h
Corrosive stress	0.2 dm ³ SO ₂ on 300 dm ³ /40 °C/1 cycle
Impulse withstand voltage at sea level	2.95 kV
Power-frequency withstand voltage	1.39 kV

Environmental and durability tests (E)

Specification	IEC 61984:2008-10
Result, degree of protection, IP code	Finger safety with IP20 test finger

Vibration test

Specification	IEC 60068-2-6:2007-12
Result	Test passed
Frequency	10 - 150 - 10 Hz
Sweep speed	1 octave/min
Amplitude	0.35 mm (10 - 60.1 Hz)
Acceleration	5 g (60.1 - 150 Hz)
Test duration per axis	2.5 h

Standards and Regulations

Connection in acc. with standard	EN-VDE
	CSA

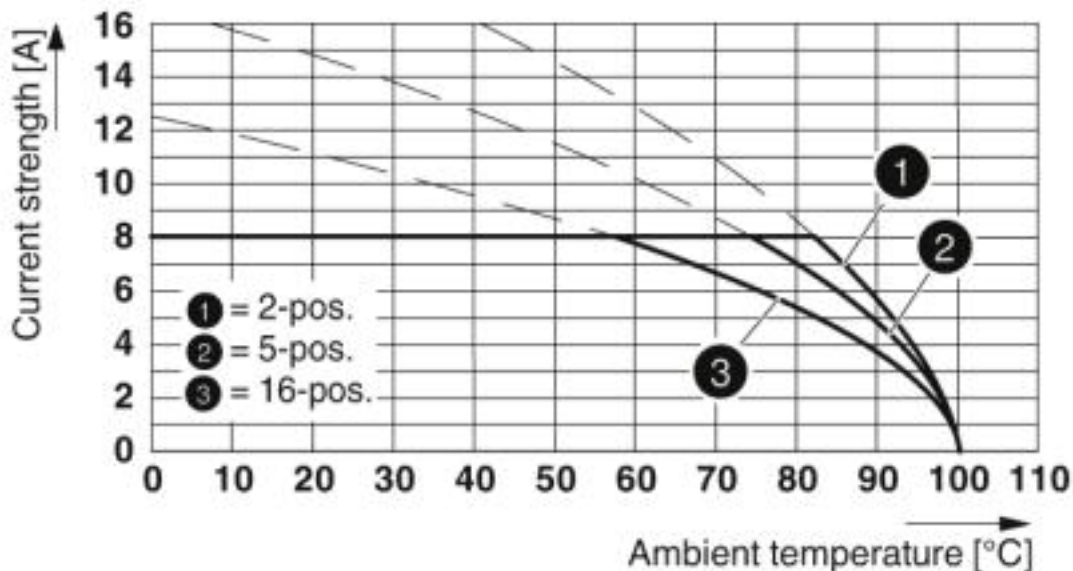
Environmental Product Compliance

REACH SVHC	Lead 7439-92-1
China RoHS	Environmentally Friendly Use Period = 50 years
	For details about hazardous substances go to tab "Downloads", Category "Manufacturer's declaration"

Drawings

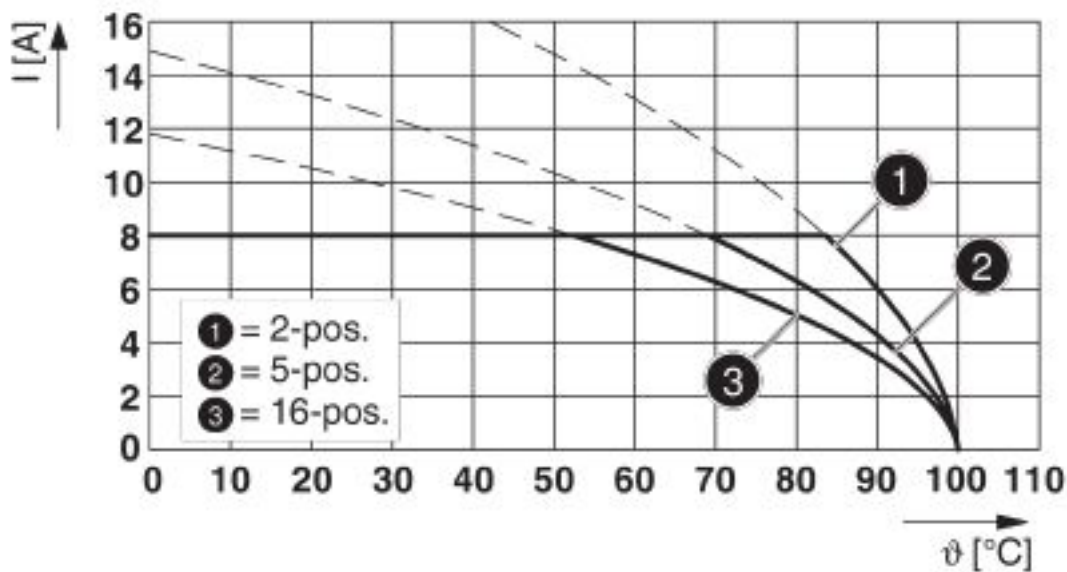
Printed-circuit board connector - MCD 1,5/14-G1F-3,81 BK - 1732658

Diagram



Type: MC 1,5/...-STF-3,81 with MCD 1,5/...-G1F-3,81

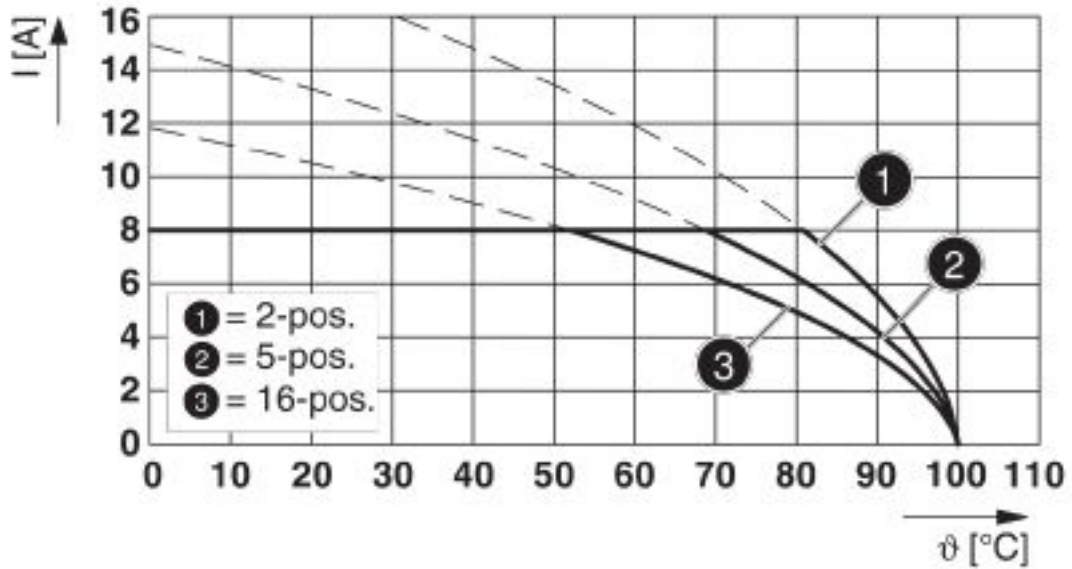
Diagram



Type: FK-MCP 1,5/...-STF-3,81 with MCD 1,5/...-G1F-3,81

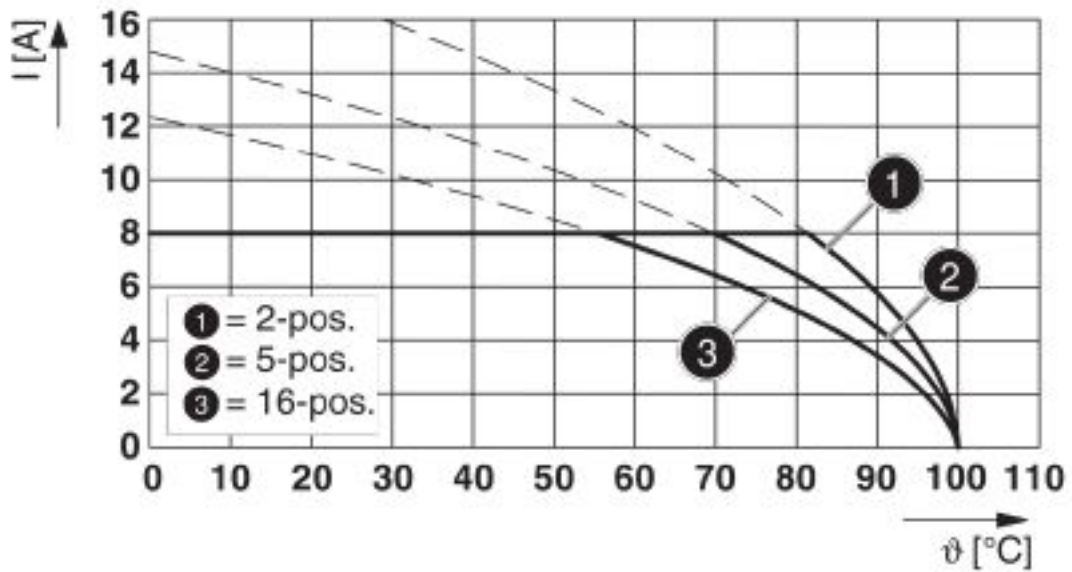
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Diagram



Type: FRONT-MC 1,5/...-STF-3,81 with MCD 1,5/...-G1F-3,81

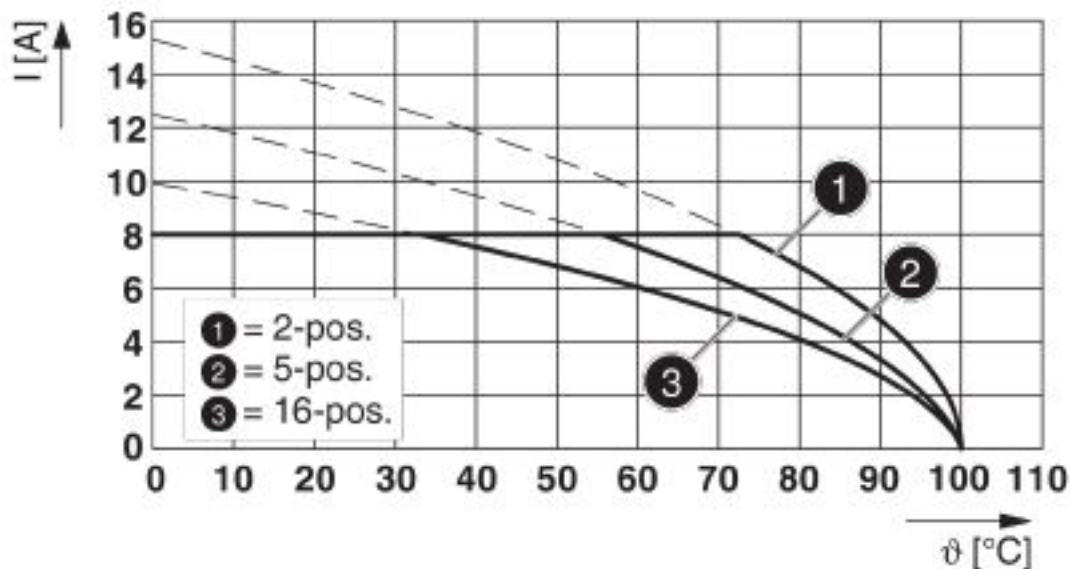
Diagram



Type: FMC 1,5/...-STF-3,81 with MCD 1,5/...-G1F-3,81

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Diagram



Type: MCV(W/R) 1,5/...-STF-3,81 with MCD 1,5/...-G1F-3,81

Classifications

eCl@ss

eCl@ss 4.0	27260700
eCl@ss 4.1	27260700
eCl@ss 5.0	27260700
eCl@ss 5.1	27260700
eCl@ss 6.0	27260700
eCl@ss 7.0	27440402
eCl@ss 8.0	27440402
eCl@ss 9.0	27440402

ETIM

ETIM 3.0	EC001121
ETIM 4.0	EC002637
ETIM 5.0	EC002637
ETIM 6.0	EC002637
ETIM 7.0	EC002637

UNSPSC

UNSPSC 6.01	30211810
UNSPSC 7.0901	39121409
UNSPSC 11	39121409
UNSPSC 12.01	39121409
UNSPSC 13.2	39121409

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Classifications

UNSPSC

UNSPSC 18.0	39121409
UNSPSC 19.0	39121409
UNSPSC 20.0	39121409
UNSPSC 21.0	39121409

Approvals

Approvals


Approvals


CSA / IEC EE CB Scheme / VDE Gutachten mit Fertigungsüberwachung / EAC / cULus Recognized

Ex Approvals

Approval details

CSA		http://www.csagroup.org/services-industries/product-listing/	13631
		B	D
Nominal voltage UN		300 V	300 V
Nominal current IN		8 A	8 A


IECEE CB Scheme		http://www.iecee.org/	DE1-60987-B1B2
Nominal voltage UN		160 V	
Nominal current IN		8 A	

VDE Gutachten mit Fertigungsüberwachung		http://www2.vde.com/de/Institut/Online-Service/VDE-gepruefteProdukte/Seiten/Online-Suche.aspx	40011723
Nominal voltage UN		160 V	
Nominal current IN		8 A	

EAC			B.01687
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Approvals

cULus Recognized		http://database.ul.com/cgi-bin/XYV/template/LISEXT/1FRAME/index.htm	E60425-20110128
	B	D	
Nominal voltage UN	300 V	300 V	
Nominal current IN	8 A	8 A	